



# P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)		
- 30	0.200 at V <sub>GS</sub> = - 10 V	- 2.0		
	0.355 at V <sub>GS</sub> = - 4.5 V	- 1.6		

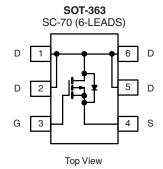
#### **FEATURES**

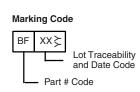
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- Compliant to RoHS Directive 2002/95/EC



#### **APPLICATIONS**

- Load Switch
  - Notebook PC
  - Servers





Ordering Information: Si1431DH-T1-E3 (Lead (Pb)-free)

Si1431DH-T1-GE3 (Lead (Pb)-free and Halogen-free)

<b>ABSOLUTE MAXIMUM RATINGS</b> T <sub>A</sub> = 25 °C, unless otherwise noted					
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	- 30		V
Gate-Source Voltage		V <sub>GS</sub>	± 20		
Continuous Drain Current /T 150 °C\a	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 2.0	- 1.7	^
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 85 °C		- 1.5	- 1.2	
Pulsed Drain Current		I <sub>DM</sub>	- 8		Α
Continuous Diode Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	- 1.2	- 0.8	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.45	0.95	W
Maximum Fower Dissipation	T <sub>A</sub> = 85 °C		0.75	0.5	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a</sup>	t ≤ 5 s	R <sub>thJA</sub>	65	85	°C/W
Maximum sunction-to-Ambient	Steady State		105	130	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	40	50	

Note:

a. Surface mounted on 1" x 1" FR4 board.

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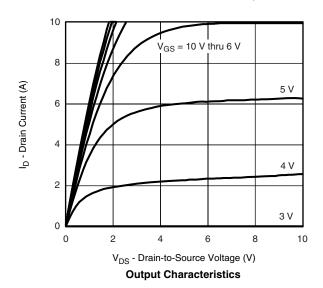


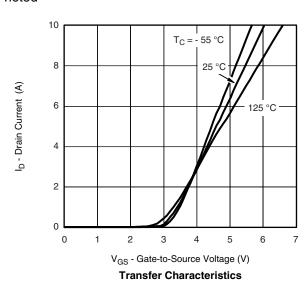
SPECIFICATIONS $T_J = 25$ °	C, unless	otherwise noted					
Parameter	Symbol	Test Conditions Min. Typ.		Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -100 \mu A$	- 1		- 3	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	,	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V			- 1		
	I <sub>DSS</sub>	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 85 °C			- 5	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = - 5 V, V <sub>GS</sub> = - 4.5 V	- 4			Α	
Drain Course On Ctata Desistance	Б	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 2.0 A		0.160	0.200	0	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 1.6 A		0.285	0.355	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 2.0 A		2		S	
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	I <sub>S</sub> = - 1.2 A, V <sub>GS</sub> = 0 V		- 0.85	- 1.2	V	
Dynamic <sup>b</sup>							
Total Gate Charge	Qg			2.4	4		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -2.0 \text{ A}$		0.8		nC	
Gate-Drain Charge	Q <sub>gd</sub>			1.3			
Gate Resistance	$R_g$	f = 1.0 MHz		9		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = - 15 V, $R_L$ = 15 Ω $I_D \cong$ - 1 A, $V_{GEN}$ = - 10 V, $R_g$ = 6 Ω		55	80		
Rise Time	t <sub>r</sub>			40	60		
Turn-Off Delay Time	t <sub>d(off)</sub>			10	20	ns	
Fall Time	t <sub>f</sub>			10	20		

#### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





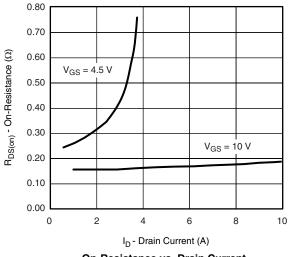
a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

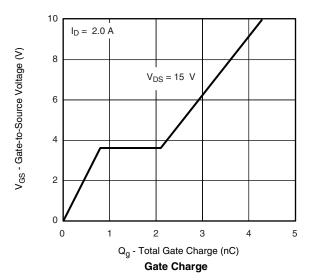


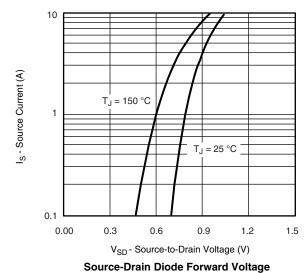


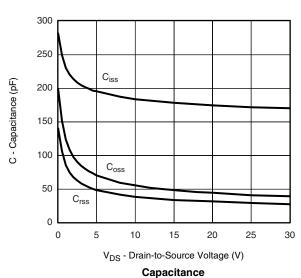
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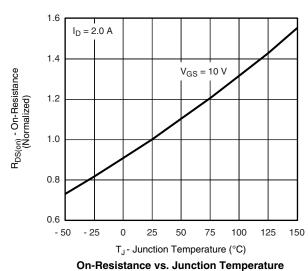


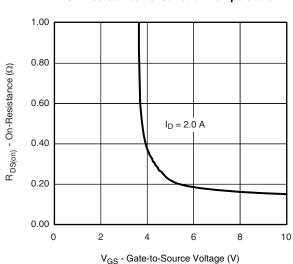
#### On-Resistance vs. Drain Current









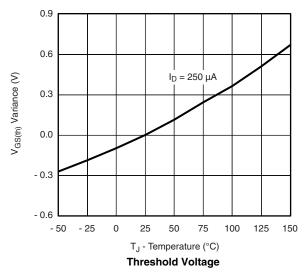


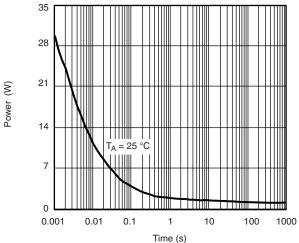
On-Resistance vs. Gate-to-Source Voltage

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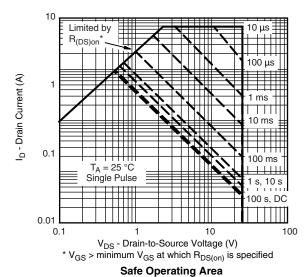
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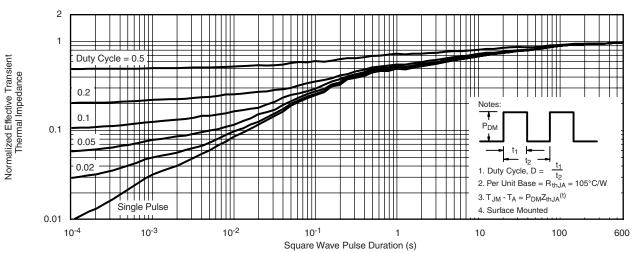
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Single Pulse Power, Junction-to-Ambient

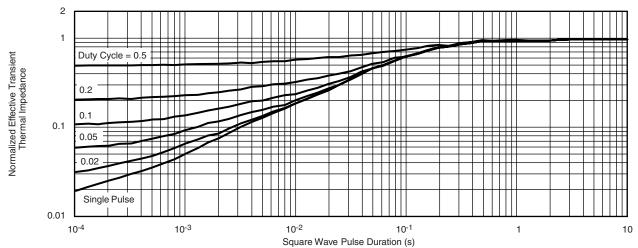




Normalized Thermal Transient Impedance, Junction-to-Ambient



## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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Document Number: 91000
Revision: 18-Jul-08
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